POLYTEC / RADIANT TECHNOLOGIES, INC.

Thin Film Piezoelectric Test Bundle - VibroOne

Polytec Laser Vibrometers attached to a Radiant Test System accurately measure the piezoelectric coefficient (d33) of thin piezoelectric films deposited on cantilevers and membranes or clamped to a substrate. A Thermal Stage can be added to the Thin Film Piezoelectric Test Bundle to measure -196C up to 600C in a single test profile.

- ☑ Reproducible
- Simple toOperate
- ✓ Versatile & Flexible



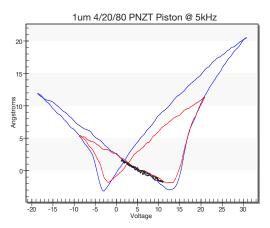
Radiant Tester and VibroOne Laser



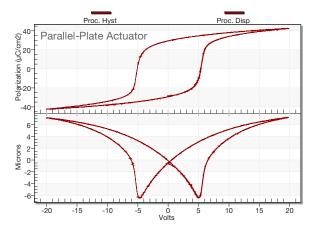
Radiant Tester, VibroOne Laser and Temperature Stage

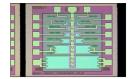
- Radiant's PiezoMEMS
 Analyzer, Multiferroic II and
 Precision LCII Testers use 18-bit ADC's, have 76 microvolt
 per bit resolution, and exhibit a noise floor of~300µV for a single pass
- The Thin Film Piezo Test
 Bundle can reach 0.2 Angstrom
 (0.02nm) resolution in d33
 piston motion with the Polytec
 VibroOne
- The 2µm spot size is perfectly suited for measuring production pMEMS devices in situ.

Butterfly Motion



d33 with NLV







Angstrom-level clamped thin piezoelectric film measurement

For More Information on the Thin Film Piezoelectric Test Bundle contact Radiant Technologies, Inc at 505.842.8007

